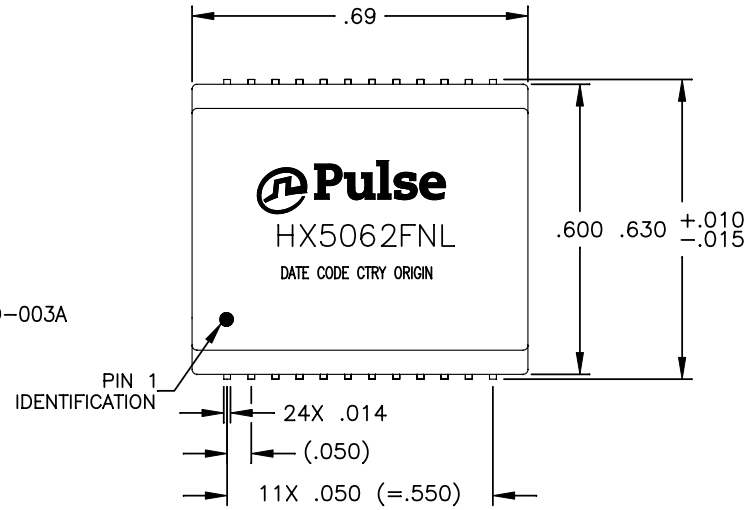
Pulse Electronics
www.pulseelectronics.com

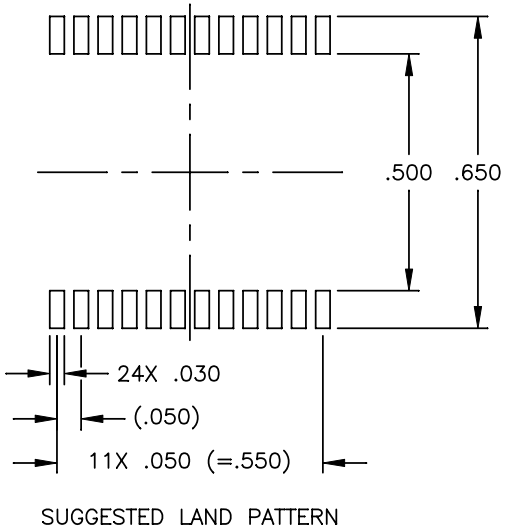
NOTES: UNLESS OTHERWISE SPECIFIED

1.

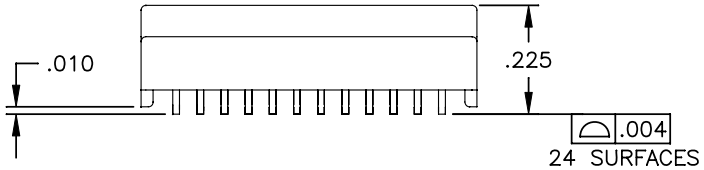
NOTICE:	THIS IS A RoHS COMPLIANT COMPONENT/PRODUCT. ALL ENGINEERING CHANGES MUST HAVE PRIOR APPROVAL BY THE DESIGN CENTER.
RoHS ✓	

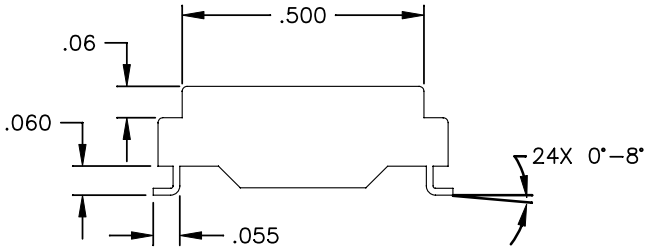
2. PLASTIC: THERMOSET PLASTIC MATERIAL WITH FLAMMABILITY RATING UL 94V–0 OR BETTER.
3. SOLDERABILITY: CONFORMS TO ANSI/J–STD–002, 245°C REFLOW PEAK TEMPERATURE PER IPC/EIA J–STD–003A
4. OPERATING TEMPERATURE: –40°C TO +85°C
5. STORAGE TEMPERATURE: –50°C TO +125°C
6. JEDEC MOISTURE: LEVEL 1.
7. DIMENSIONS ARE IN INCHES WITH THE FOLLOWING TOLERANCES:
   .XX= ±.02
   .XXX= ±.010
8. REVISION: MP1,MP2, ... ARE PRELIMINARY.





SUGGESTED LAND PATTERN





PULSE CONFIDENTIAL & PROPRIETARY	PRODUCT DESCRIPTION	PS DRAWING	SHEET:	DWG. NO./ PART NO.	REV.
	MDL,SIN,1GD,1:1,SM,OH	PS–2597.001–04	1	HX5062FNL	MP1

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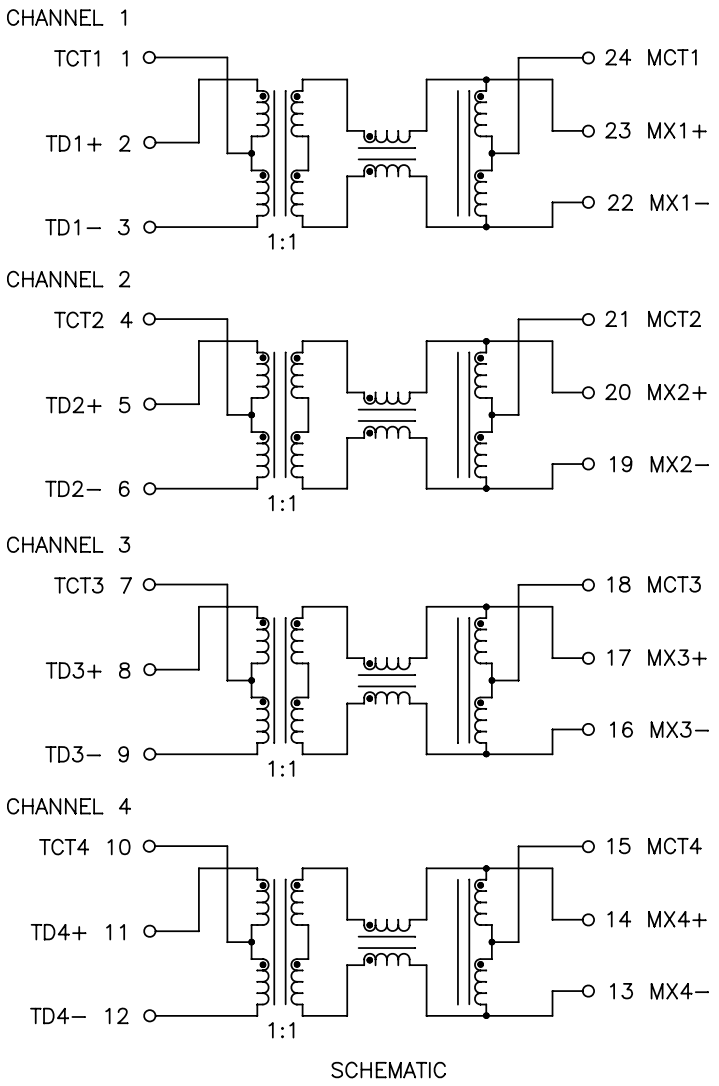
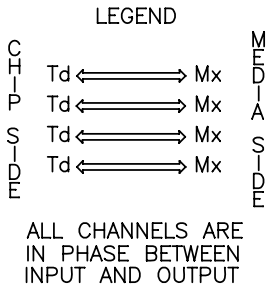


SCHEMATIC



ALL CHANNELS ARE IN PHASE BETWEEN INPUT AND OUTPUT

ELECTRICAL CHARACTERISTICS AT +25°C

PARAMETER	SPECIFICATIONS	
OPERATING TEMP	−40°C ~ +85°C	
TURNS RATIO	1 : 1 ±2%	
POLARITY	PER SCHEMATIC	
INSERTION LOSS	100 KHz	1−125 MHz
	−1.2 dB MAX	$-0.2-0.002*f^{1.4}$ dB MAX
RETURN LOSS (Z OUT = 100 OHM ±15%)	.1−40 MHz	40−100 MHz
	−16 dB MIN	$-10+20*\text{LOG}_{10}(f/80\ \text{MHz})$ dB MIN
INDUCTANCE (OCL) (MEDIA SIDE, −40°C~85°C)	350 uH MIN	(MEASURED AT 100 KHz, 100 mVRMS AND WITH 8 mA DC BIAS)
CROSSTALK, ADJACENT CHANNELS	1 MHz	10−100 MHz
	−50 dB MIN	$-55+22*\text{LOG}_{10}(f/10)$ dB MIN
COMMON MODE REJECTION RATIO	2 MHz	30−200 MHz
	−50 dB MIN	$-15+20*\text{LOG}_{10}(f/200)$ dB MIN
DC RESISTANCE, 1/2 WINDING	.65 OHMS MAX	
DC RESISTANCE IMBALANCE	±.065 OHMS MAX (CENTER TAP SYMMETRY)	
INPUT − OUTPUT ISOLATION	1500 VRMS MIN @ 60 SECONDS	

NOTE: f IS FREQUENCY IN MHz.

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